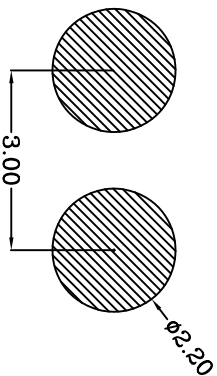
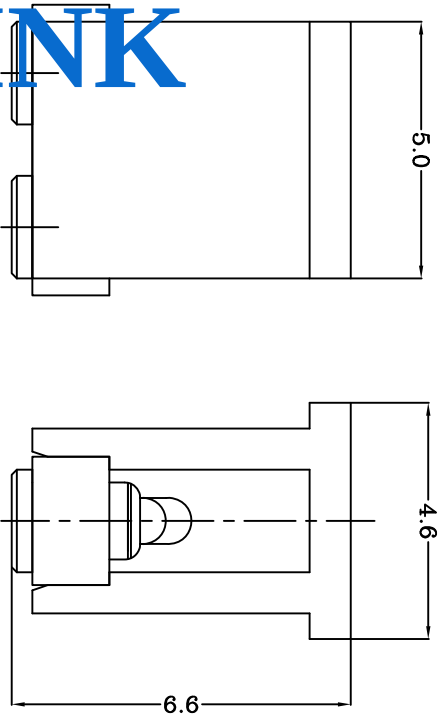
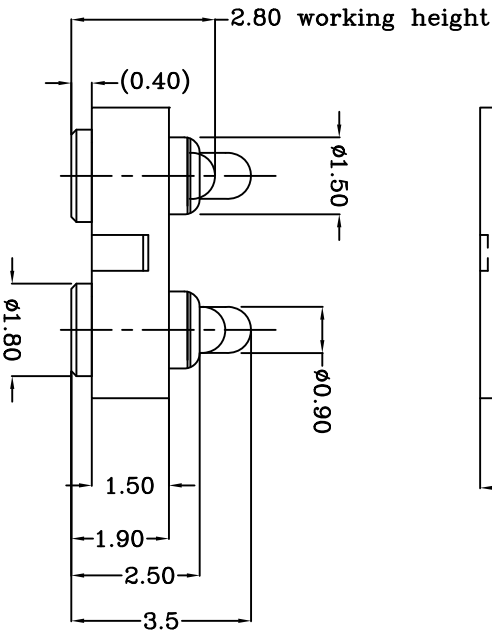
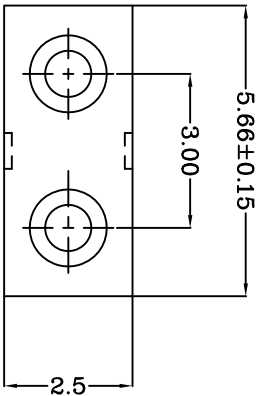


DWG NO.
C-100272

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TOP-LINK

Recommended solder paste thickness is 0.10 mm

Recommended PCB Layout

- Notes:
- 1 Material, Housing: PA 4,6 (30% Glass Filled)
Color: Black.
 - 2 Mechanical demands:
Contact: Brass
Plating Plunger: 0.4µm Au over 1.4µm Ni
Plating Body: 0.1µm Au over 1.4µm Ni.

LDC
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DIST
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NEW		2011/03/29
REVISION		
RECORD		
APVD		
DATE		

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED			
0	= ±		
0.0	= ±0.15		
0.00	= ±0.10		
0.000	= ±		
ANGLE: ±1°			
SURF TEXTURE: 32/			
REMOVE BURRS, BREAK			
SHARP EDGES R0.05 MAX			
DO NOT SCALE PRINT			
MATL	1	HT TR	—
DWN	Benny	APVD	Lansing
CHK	Andy	REL	Top-Link Electronics
NAME	BATTERY POGD CONNECTOR 2 POSITIONS		
SCALE	1:1	DWG	PGC-1S-3S-R-2P-3.0PH
SCALE	A4	NO.	C-100272
SHEET	1 OF 1	REV	B

100272-2
PART NUMBER

USED ON
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